

**Conductance study of magnetic tunnel junctions
with an ultrathin MgO barrier**

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A magnetic tunnel junctions (MTJs) multilayer stack was studied, consisting of the following materials (thickness in nm): PtMn(16)/Co₇₀Fe₃₀(2.0)/Ru(0.9)/Co₄₀Fe₄₀B₂₀(2.3)/MgO t_{MgO} /Co₄₀Fe₄₀B₂₀(2.3). MgO barrier thickness (t_{MgO}) ranged from 0.6 to 1 nm, corresponding to a Resistance-Area (RA) products below $10 \Omega\mu m^2$ and a Tunnel Magnetoresistance (TMR) ratio above 180 %. Stacks were prepared with varied Ar partial pressure (p_{Ar}) during MgO sputtering. Low p_{Ar} range was 1-3.8 mTorr, whilst high p_{Ar} was in the range 5.6-15 mTorr. For low tunnel barrier thickness ($t_{MgO} < 0.7$ nm) the appearance of structural defects is very likely. An extension of equivalent circuit model [Oliver et al. J.Appl. Phys. 91 4348 (2002)] was applied to the current-in-plane tunneling measurements of the multilayer stack wafer in order to analyse effect of p_{Ar} and t_{MgO} on TMR and RA. Good agreement was achieved between the model and experimental results of the shunt resistance contribution to conductance as a function of t_{MgO} for various p_{Ar} . Our approach can be very useful for characterization of the unpatterned MTJ wafers. **Acknowledgments:** Project supported by SPIN SWITCH MRTN-CT-2006-035327, the Polish Ministry of Science and Higher Education grants (IP 2010037970 and NN 515544538), and the Foundation for Polish Science MPD Programme cofinanced by the EU European Regional Development Fund.

9.7 cm

13.4 cm

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